

# RGBP1010027-PCTC3 Multi-Wavelength SMD Type

## Features

- Top view 1010 package
- Wide viewing angle
- RGB individual control
- High reliability
- RoHS compliance

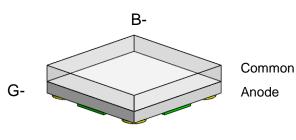
# Applications

- General lighting
- Indoor signage display applications
- Switch light
- Decorative and Entertainment lighting

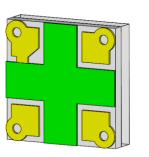
### Description

The RGBP1010027-PCTC3 is a high brightness device designed for demanding applications in efficiency and reduced space. An ideal device in emphasizing visual effects, advertisement, decoration as well as general backlighting needs.

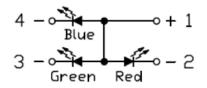
# **Package Outline**



R-



# Schematic





# Absolute Maximum Rating at 25°C

Symbol	Parameters		Ratings	Units	Notes
		R	20		
IF	Continuous Forward Current	G	20	mA	
		В	20		
		R	60		
I <sub>FP</sub>	Peak Forward Current	G	100	mA	1
		В	100		
VR	Reverse Voltage		5	V	
T <sub>opr</sub>	Operating Temperature		-40 ~ +85	0 <b>C</b>	
T <sub>stg</sub>	Storage Temperature		-40 ~ +100	٥C	
T <sub>sol</sub>	Soldering Temperature		260	0 <b>C</b>	2
	Device Dissipation of (as halow) 0500 Frage Air	R	60		
PD	Power Dissipation at(or below) 25°C Free Air	G	95	mW	
	Temperature	В	95	1	

### Electro-Optical Characteristics TA = 25°C (unless otherwise specified)

### **Optical Characteristics (Red)**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lv	Luminous Intensity	I⊧=5mA	112	-	180	mcd	3
λd	Dominant Wavelength	I⊧=5mA	-	620	-	nm	4
θ1/2	Angle of Half Intensity	I⊧=5mA	-	±60	-	deg	

### **Electrical Characteristics (Red)**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward Voltage	I⊧=5mA	1.7	-	2.4	V	
I <sub>R</sub>	Reverse Current	V <sub>R</sub> =5V	-	-	1	μA	



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### **Optical Characteristics (Green)**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lv	Luminous Intensity	I⊧=5mA	140	-	285	mcd	3
λd	Dominant Wavelength	I⊧=5mA	515	-	530	nm	4
θ1/2	Angle of Half Intensity	I⊧=5mA	-	±60	-	deg	

### **Electrical Characteristics (Green)**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward Voltage	I⊧=5mA	2.5	-	3.2	V	
IR	Reverse Current	V <sub>R</sub> =5V	-	-	1	μA	

### **Optical Characteristics (Blue)**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lv	Luminous Intensity	I⊧=5mA	36	-	72	mcd	3
λd	Dominant Wavelength	I⊧=5mA	460	-	475	nm	4
θ1/2	Angle of Half Intensity	I⊧=5mA	-	±60	-	deg	

### **Electrical Characteristics (Blue)**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward Voltage	I⊧=5mA	2.6	-	3.3	V	
I <sub>R</sub>	Reverse Current	V <sub>R</sub> =5V	-	-	1	μA	

#### Notes:

- 1. IFP Conditions--Pulse Width $\leq 100\mu s$  and Duty $\leq 10\%$ .
- 2. Soldering time  $\leq 10$  seconds.



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#### 3. Bin Range of Luminous Intensity

		Red			
Bin Code	Min	Max	Unit	Condition	
R1	112	140	mad		
R2	140	180	mcd	l⊧=5mA	
		Green			
R2	140	180			
S1	180	225	mcd	I⊧=5mA	
S2	225	285			
		Blue			
Bin Code	Min	Max	Unit	Condition	
N2	36	45			
P1	45	57	mcd	I <sub>F</sub> =5mA	
P2	57	72			

Tolerance of Luminous Intensity ±10%

#### 4. Bin Range of Dominant Wavelength

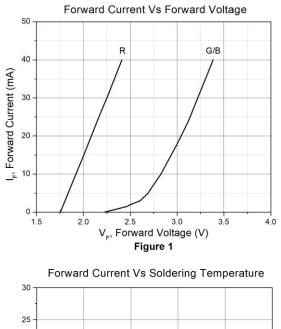
		Green		
A4	515	520		
A5	520	525	nm	I⊧=5mA
A6	525	530		
		Blue		
A5	460	465		
A6	465	470	nm	I⊧=5mA
A7	470	475		

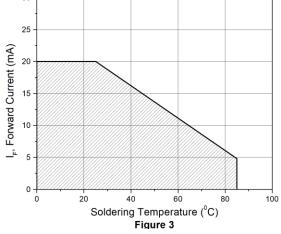
Tolerance of Dominant Wavelength: ±1nm.



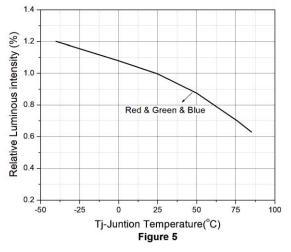
# RGBP1010027-PCTC3 Multi-Wavelength SMD Type

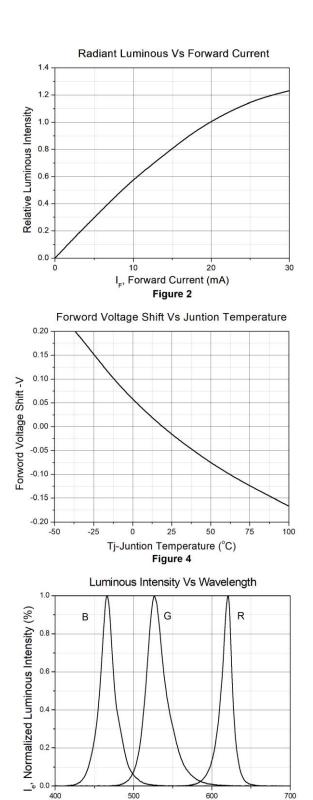
# **Typical Characteristic Curves**





Relative Luminous Intensity Vs Juntion Temperature



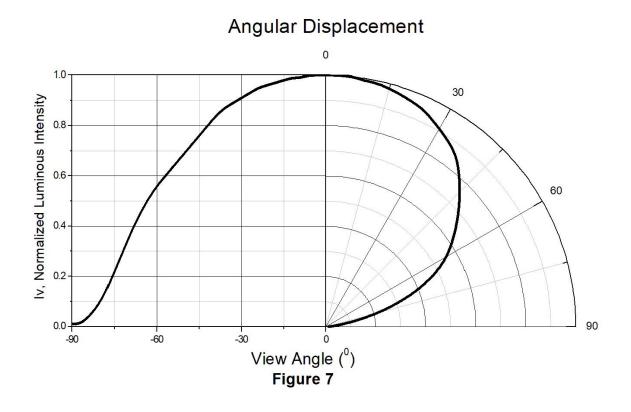


λ, Wavelength (nm)

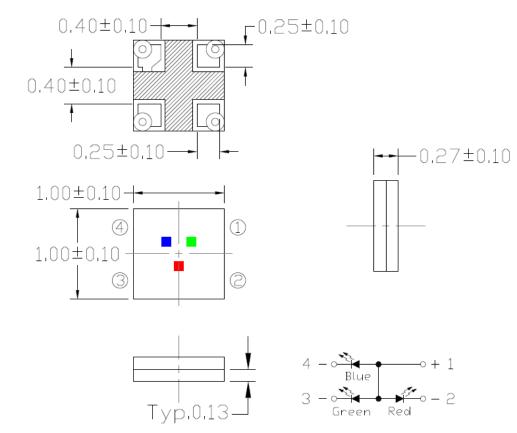
Figure 6



# **Typical Characteristic Curves**



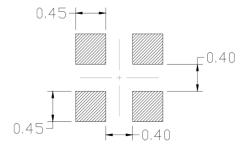




### Package Dimension All dimensions are in mm, unless otherwise stated

Note: Tolerance unless mentioned is ±0.1mm

### Recommended Soldering Mask All dimensions are in mm, unless otherwise stated



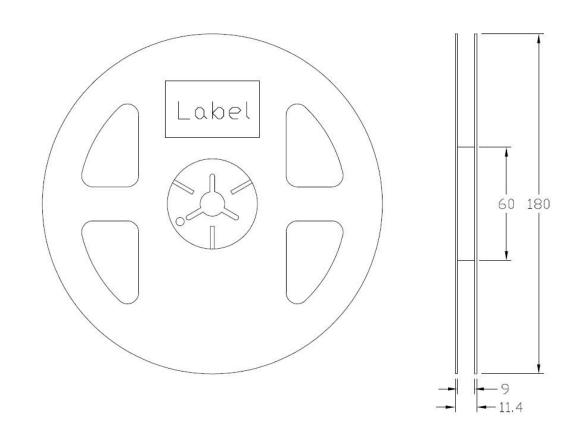
Note: Tolerance unless mentioned is ±0.1mm

# **Ordering Information**

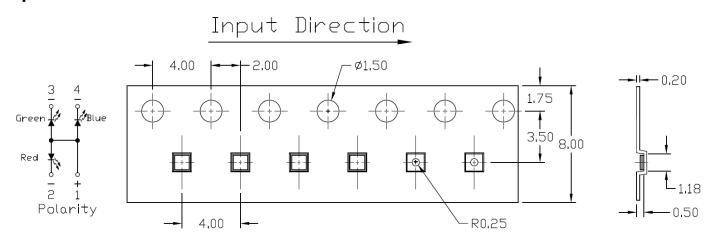
Part Number	Description	Quantity
RGBP1010027-PCTC3	Tape & Reel	3000 pcs



### Reel Dimension All dimensions are in mm, unless otherwise stated



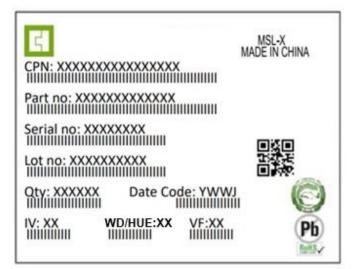
### Tape Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm



# Label Form Specification



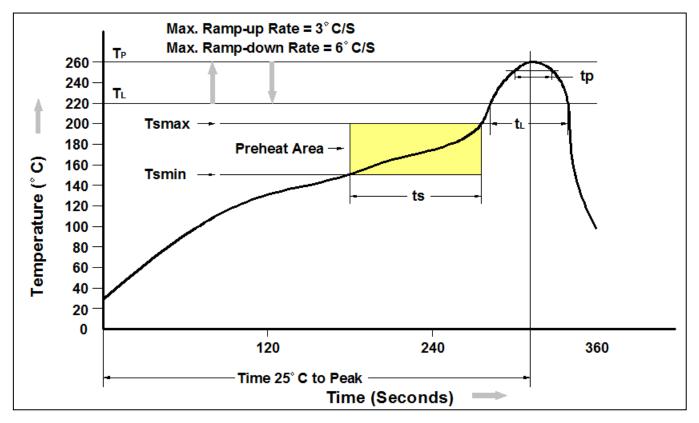
CPN : Customer Part Number Part no: CTM Production Number Serial no: Production Number Lot no: Lot number Q'ty: Packing Quantity Date Code: Manufacture Date IV : Bin Code of Luminous Intensity WD : Bin Code of Dominant Wavelength VF : Bin Code of Forward Voltage MADE IN CHINA: Production Place

# **Storage Condition**

- 1. Do not open moisture proof bag before the products are ready to use.
- 2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
- 3. After opening the moisture barrier bag floor life is 1 year at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
- 4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



## **Reflow Profile**



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t <sub>P</sub> )	3°C/second max.
Liquidous Temperature (TL)	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t <sub>P</sub> ) within 5°C of 260°C	30 seconds
Ramp-down Rate $(T_P \text{ to } T_L)$	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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